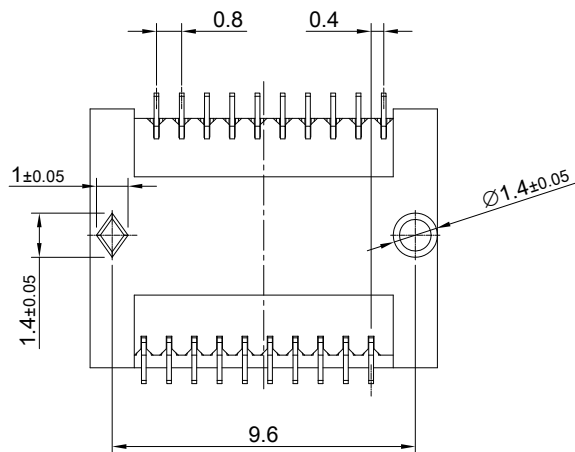


MATERIAL
 CONTACTS: COPPER ALLOY
 INSULATOR: LCP THERMOPLASTIC 94V-0
 INSULATOR COLOR: BLACK

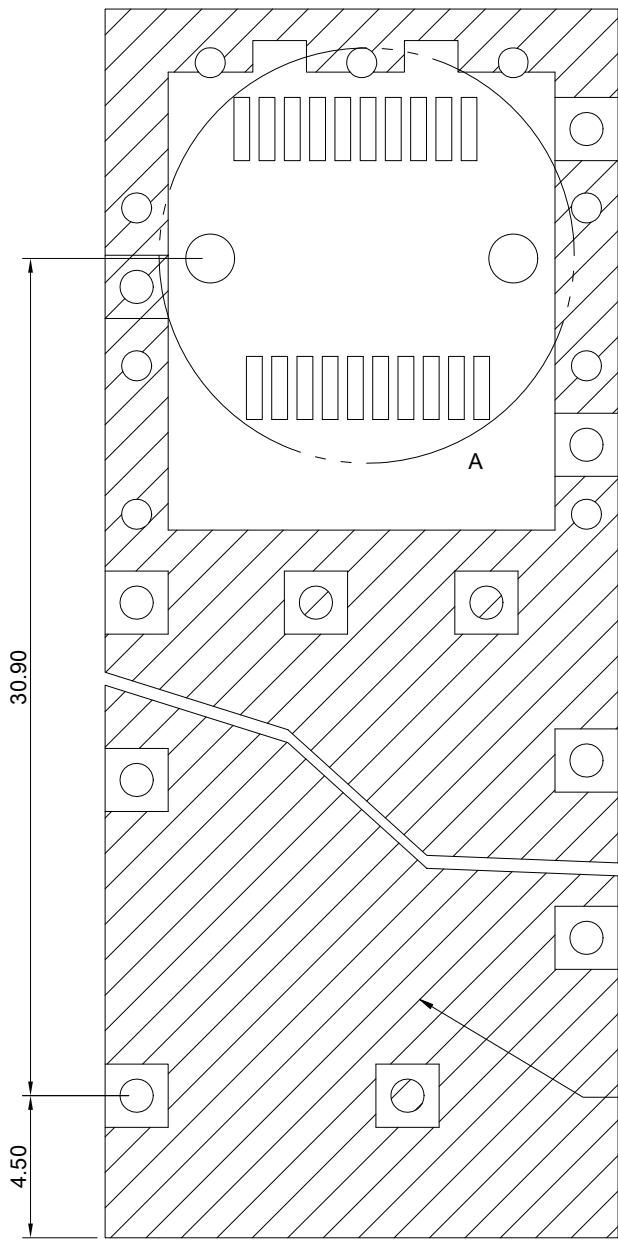
ELECTRICAL CHARACTERISTICS
 CONTACT CURRENT RATING: 0.5 AMPERE
 DIELECTRIC WITHSTANDING VOLTAGE: 300V DC
 VOLTAGE RATING: 30 VDC
 CONTACT RESISTANCE: 35 mΩ MAX.

FINISH
 CONTACTS: 15 μ" MIN. GOLD ON MATING END (SIGNAL PIN)
 ALL UNDERPLATED NICKEL
 100 μ" MATTE TIN ON SOLDER FOOT AREA

ENVIRONMENT
 OPERATION TEMPERATURE: -55°C TO 85°C
 SMT TEMPERATURE: 260°C

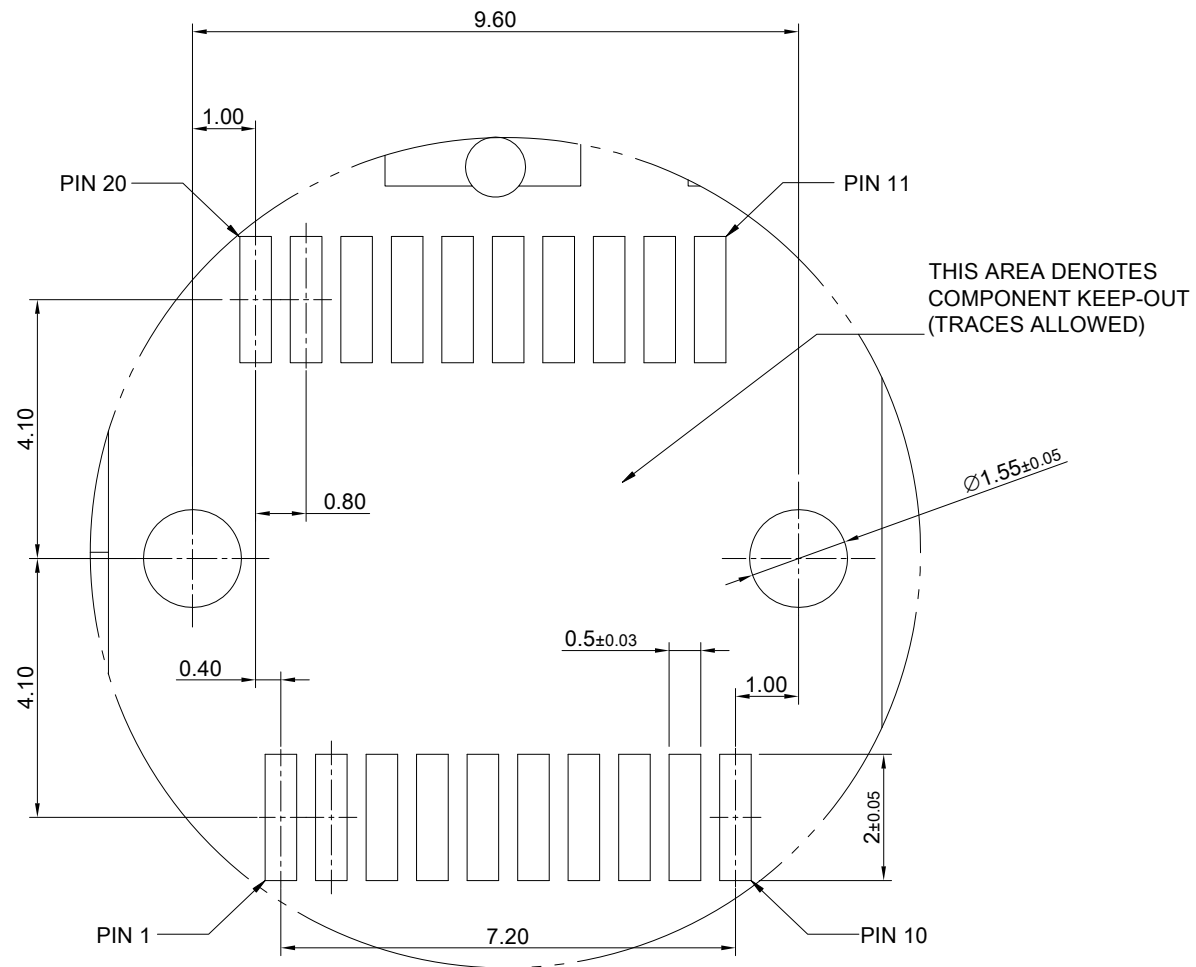


 ALL BEST ELECTRONICS CO., LTD.	TITLE: SFP 20Pin SMT Connector		SHEET: 1/2	REV. D
	DWG#: R-SS-008020-3-N		CHECKED: Gary Kang	
	UNIT: mm	SCALE: A4 4:1	FINISH:	APPROVED: George Yang
	TOLERANCE: Angle: ± 1° X. ± 0.25 .X ± 0.20 .XX ± 0.15		MATERIAL: RoHS Compliant	DATE: 06/27/2019
		THIRD ANGLE PROJECTION	DRAWN: Andy	





20 CIRCUIT MOTHER BOARD
RECOMMENDED PCB LAYOUT
TOLERANCE: ± 0.05

CROSS HATCHED AREA DENOTES
COMPONENT AND TRACE KEEP-OUT
(EXCEPT CHASSIS GROUND)



DETAIL A
SCALE 2:1

 ALL BEST ELECTRONICS CO., LTD.	TITLE: SFP 20Pin SMT Connector		SHEET: 2/2	REV. D
	DWG#: R-SS-008020-3-N		CHECKED: Gary Kang	
UNIT: mm	SCALE: A4 4:1	FINISH:	APPROVED: George Yang	
 THIRD ANGLE PROJECTION		MATERIAL: RoHS Compliant	DATE: 06/27/2019	
TOLERANCE: Angle: $\pm 1^\circ$ X: ± 0.15 .X: ± 0.10 .XX: ± 0.05		DRAWN: Andy		